

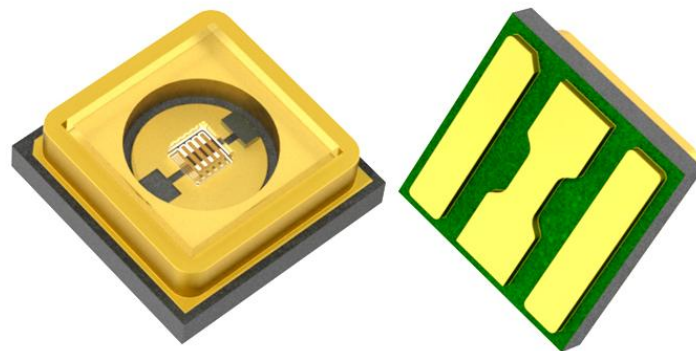
# JS35AE Product Specification

## SPECIFICATIONS OF JS35AE

File NO. : JS-OP-RD-304

Version : B/1

Effective Date : 2023-01-06



Approved by	Checked By	Prepared by
郑远志	王德	郑明兰

## Features

- AlN Ceramic
- EUTECTIC welding process
- Size:3.5\*3.5\*1.47mm
- Wide viewing angle:120°
- RoHS compliant

## Applications

- Disinfection
- Water/Air Purification
- Ultraviolet detection
- Food & Pharmaceutical Processing
- Health care

## Performance Characteristics

Electro-Optical Characteristics @100mA

Tc=22°C

Main Bin

	Parameter	Symbol	Minimum	Maximum	Unit
UVC	Forward Voltage	Vf1	5	5.5	V
			5.5	6	
			6	6.5	
			6.5	7	
			7	8	
	Output Radiant Power	Φe	5	7	mW
			7	10	
			10	15	
	Peak Wavelength	WLP	265	270	nm
			270	275	
			275	280	
			280	285	
	Spectrum Half Width	HW	8	14	nm

Notes:

- ✓ These values measured by the Jason optical spectrum analyzer

And tolerances are followings as below.

- Forward Voltage(Vf1): ±0.2V
- Output Radiant Power(Φe): ±10%
- Peak Wavelength(WLP): ±3nm

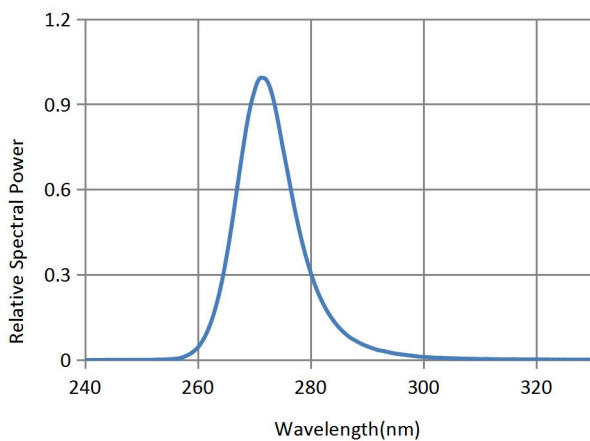
## Absolute Maximum Ratings

Parameter	Symbol	Condition	Max Rating	Unit
Forward Current	If	Ta = 22°C	120	mA
Reverse Voltage	Vr	Ta = 22°C	10	V
Operating Temperature	T	—	-30-60	°C
Storage Temperature	Tstg	Sealed Package	-40-100	°C
Soldering Temperature	T	Reflow Soldering	250-260	°C

## Typical Characteristic Curves

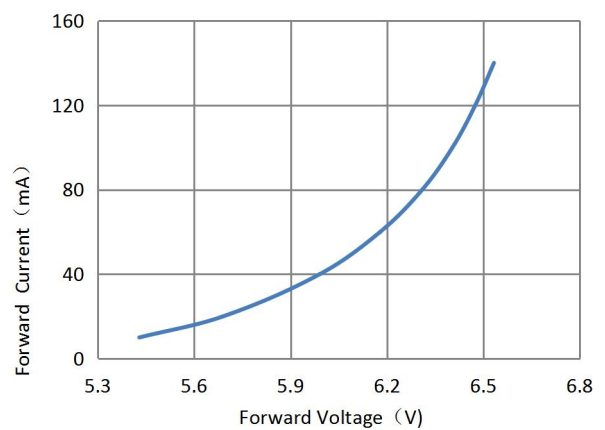
■ Spectrum

Ta=22°C If=100mA



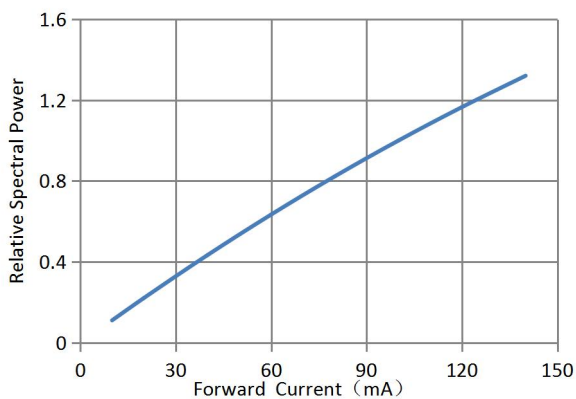
■ Forward Current vs. Forward Voltage

Ta=22°C



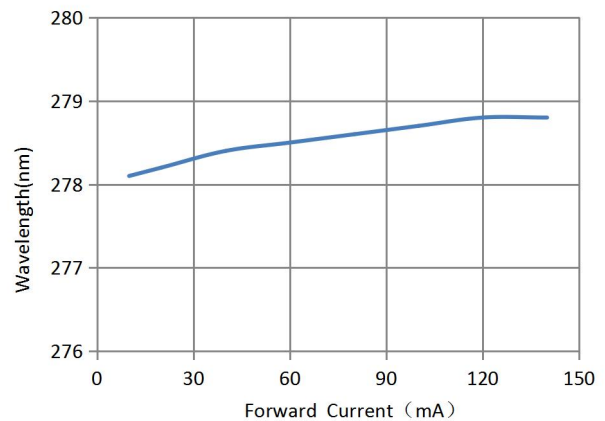
■ Relative Spectral Power vs. Forward Current

Ta=22°C

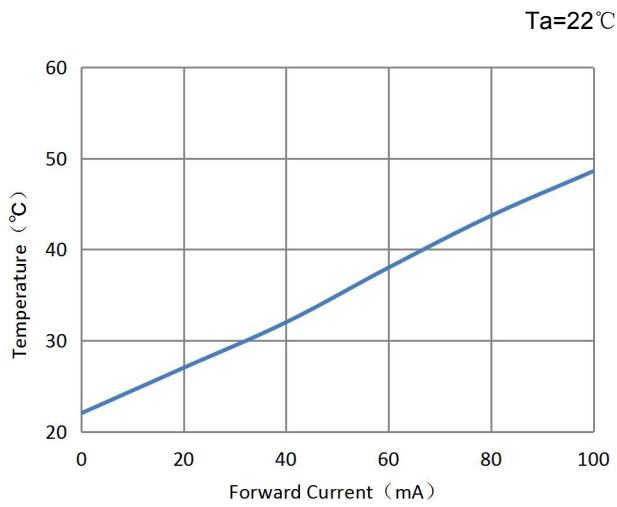


■ Wavelength vs. Forward Current

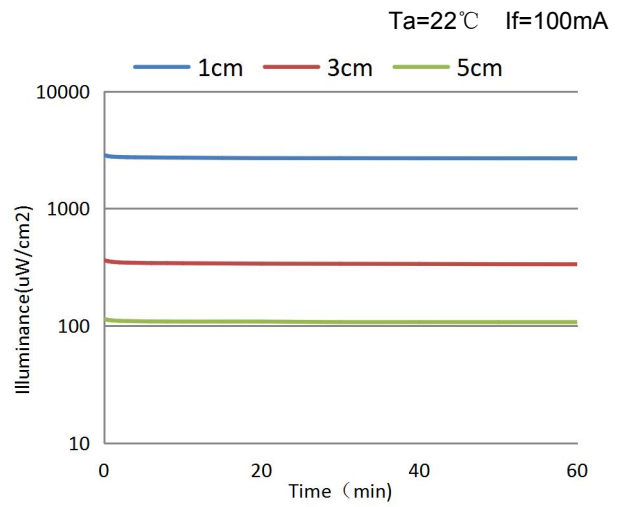
Ta=22°C



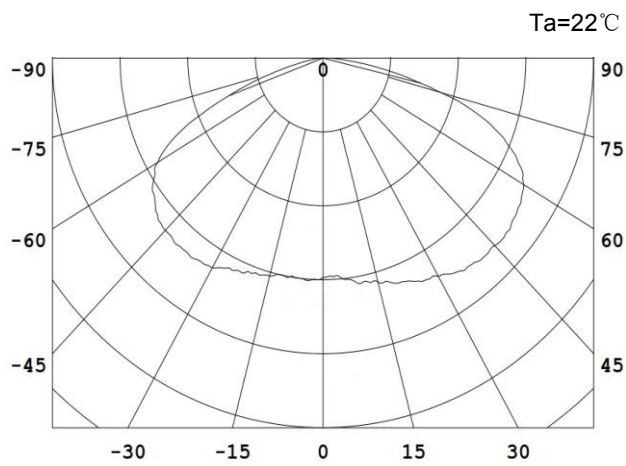
■ Temperature vs. Forward Current



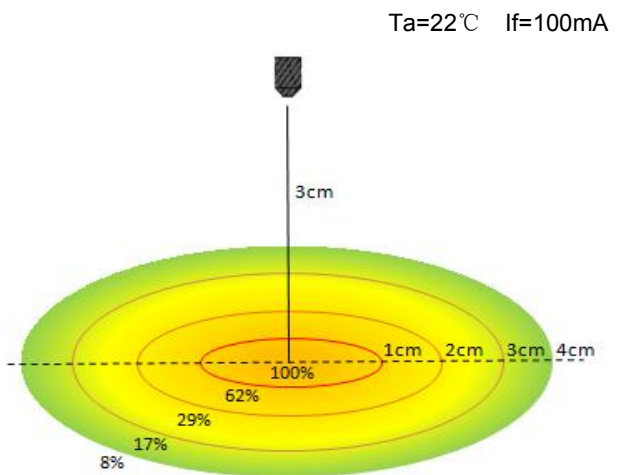
■ Illumination vs. Time



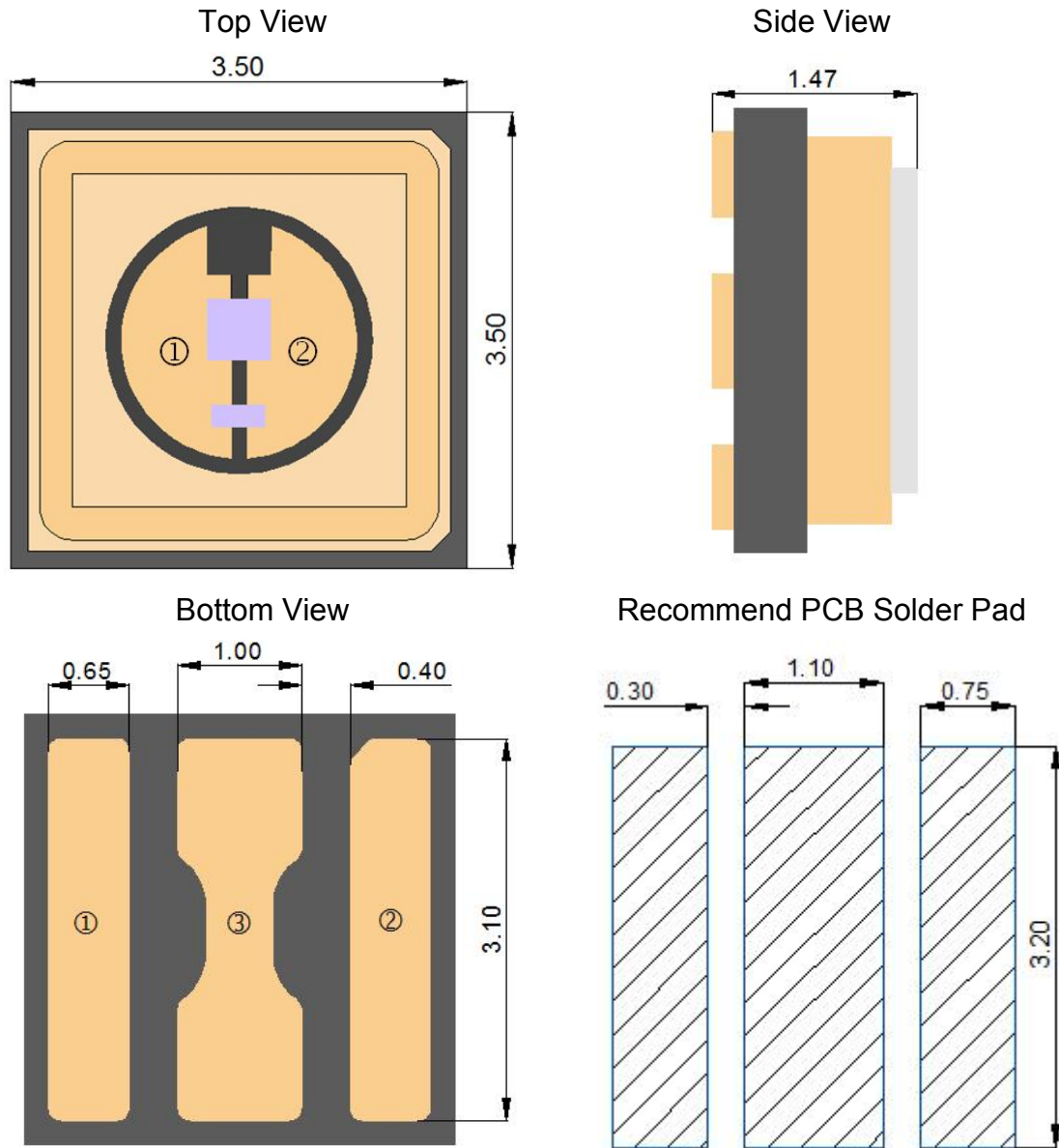
■ Radiant Pattern



■ Illumination Pattern

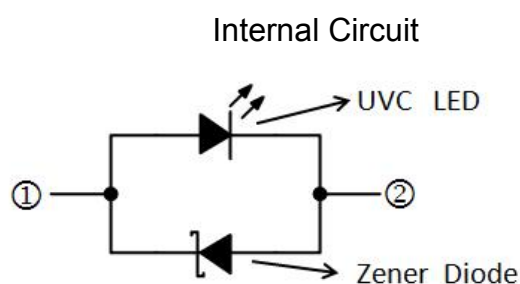


### Mechanical Dimension



notes:

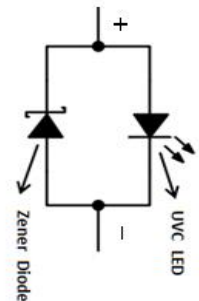
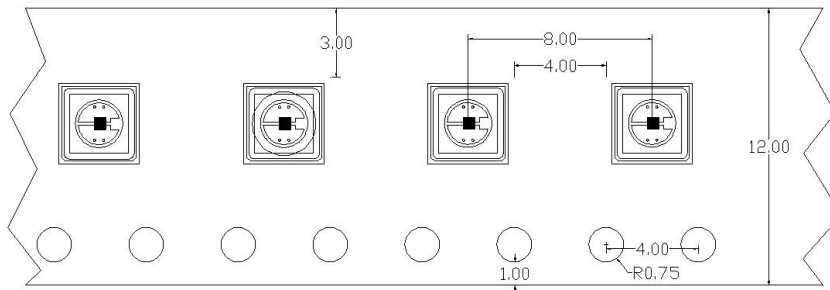
- ✓ ①Anode Pad ②Cathode Pad ③Thermal Pad
- ✓ All dimensions are in mm, Undefined tolerances are  $\pm 0.20\text{mm}$
- ✓ In addition to UV LED chip, a zener diode is welded in the device to provide ESD protection. The connection mode between LED chip and zener diode is shown in the figure below:



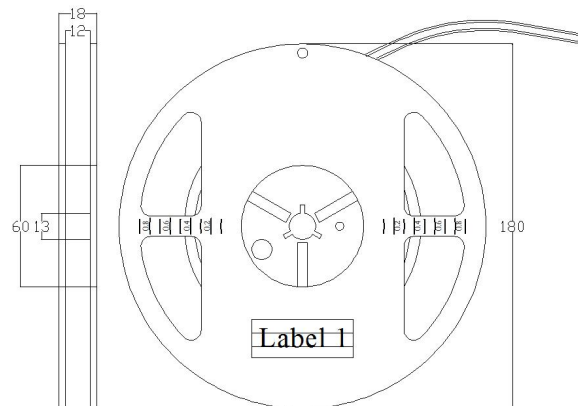
## Packaging and Labeling of Products

### Taping Outline Dimensions:

Tape:



Reel :



-Reel: Conductive PS(Black)

- Embossed Carrier Tape: conductive PS (Black)

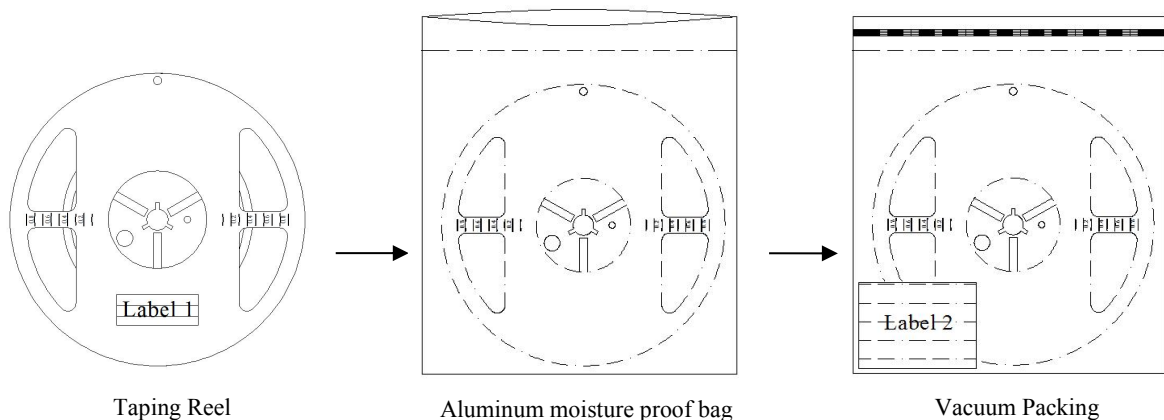
-Cover Tape: Conductive PET Base

Notes:

- ✓ Quantity: 1000pcs/Reel
- ✓ All dimensions are in mm, Undefined tolerances are  $\pm 0.2\text{mm}$

### Labeling of Products

Reeled products packed in a sealed-off and moisture-proof aluminum bag with desiccants(Silica Gel)



Taping Reel

Aluminum moisture proof bag




Vacuum Packing

Label

<Label 1>—size:30\*60mm:

WLP(nm)	270.0	280.0	EA06
Po(mW)	7.0	10.0	
Vf(V)	6.0	6.2	
@100mA	Qty:	1000	

<Label 2 >— size:55\*75mm:

HeaChips®		Jason Semiconductor Co.Ltd.	
Lot No.	JS35AE20W20610001	GP   RoHS	
Tape No.	JS35AEE0627C7AAAA		
			
@ 100mA	Min	Max	
WLP (nm)	270.0	280.0	
Po (mW)	7.0	10.0	
Vf (V)	6.0	6.2	
Qty:	1000		

Lot No. Indication:

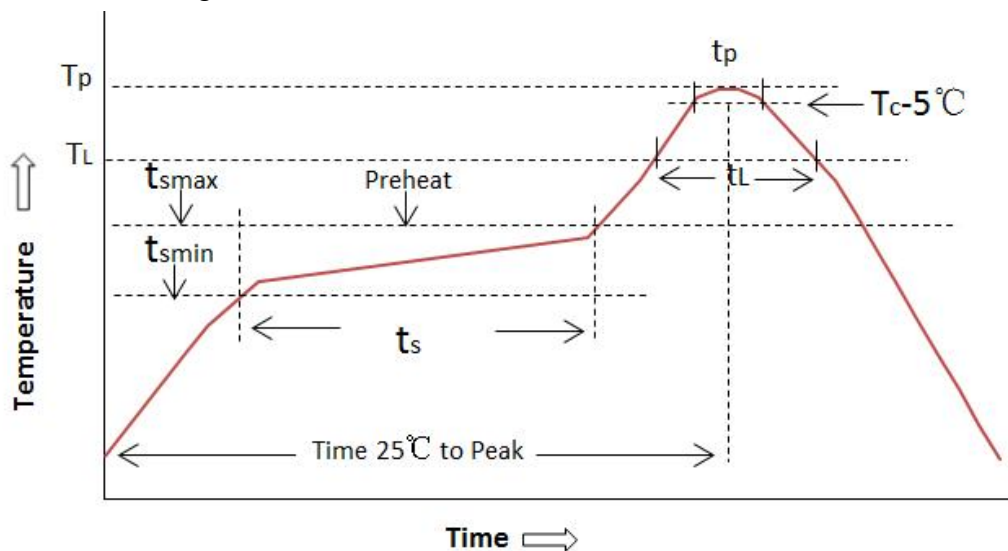
JS	35AE	20W	20610	001
Manufacturer Code	Product Model	Chip Model	Date	Serial No.

Tape No. Indication:

Tape No. Code	Description
JS	Manufacturer Code
35AE	Product Model
E06	Bin No.
27C	Peak Wavelength
7	Luminous Power Min.
A	Luminous Power Max.
A	Voltage Code
A	Parameter Grade
A	Appearance Grade

## Reflow Soldering

The maximum tolerance temperature of the ball is 260°C (short time), Reflow welding can be performed with high and low temperature solder welding. The parameters can be performed with reference to the JEDEC J-STD-020D standard. The temperature curve refers to the following chart.



Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Ts_min	100°C	150°C
Ts_max	150°C	200°C
Ts(Ts_min to Ts_max)	60~120sec	60~120sec
Ramp-Up Rate (Ts_max To Tp)	3°C/sec Max	3°C/sec Max
Liquidus Temperature	183°C	217°C
Peak Temperature (Tp)	235°C	260°C
Peak temperature duration (Tp)	20 sec	30sec
Ramp-Down Rate	6°C/sec Max	6°C/sec Max
25 °C to peak temperature time	6 minutes Max	8 minutes Max

Notes:

- ✓ Temperature Profile should be the scene of the solder paste used type, proportion, reflow soldering equipment to change and adjust accordingly.
- ✓ Inappropriate reflux temperature, reflux time may cause the LEDs welding failure. Suggest to do more testing before mass production, to ensure optimum technological parameters.
- ✓ Reflow soldering should not be done more than two times.
- ✓ When soldering, do not put stress on the LEDs during heating.
- ✓ After soldering, do not warp the circuit board.



## Cautions on Use

### Moisture-Proof Package

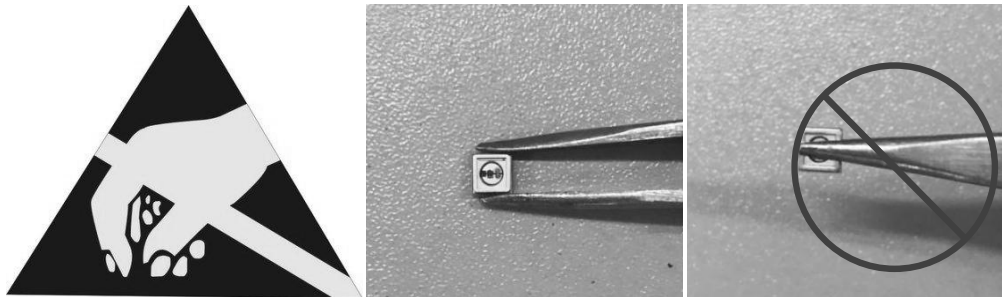
The moisture in the SMD package may vaporize and expand during soldering. The moisture can damage the optical characteristics of the LEDs due to the encapsulation.

### During Storage

Conditions		Temperature	Humidity	Time
Storage	Before Opening Aluminum Bag	5°C~30°C	<50%RH	Within 1 Year from the Delivery Date
	After Opening Aluminum Bag	5°C~30°C	<60%RH	≤672hours
Baking		65°C±5°C	<10%RH	10~24hours

### During Usage

- The LED should avoid direct contact with hazardous materials such as sulfur , chlorine, phthalate, HF, etc.
- The metal parts on the LED can rust when exposed to corrosive gases. Therefore, exposure to corrosive gases must be avoided during operation and storage.
- Extreme environments such as sudden ambient temperature changes or high humidity that can cause condensation must be avoided.



### Product cleaning

If the product needs to be cleaned, (IPA) is recommended as a cleaning agent for surface cleaning, Do not use any acid solution for surface cleaning, especially (BOE).

### Suggestions for Circuit design

The distribution of current and voltage should be fully considered in the circuit design to avoid exceeding the absolute maximum rated parameters of the product. In order to ensure the best use effect, it is suggested to assign a resistor series connection to each product in the Matrix circuit.

**Important Safety Guidelines**

- Do not Look straight at the light when the LEDs are on.
- Be careful not to damage your eyes when observe the LEDs with optical instruments.

